



BSS138DWQ

### **DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR**

## **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> Max      | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|----------------------|------------------------------|----------------------------------------------|
| 50V                  | 3.5Ω @ V <sub>GS</sub> = 10V | 200mA                                        |

## **Description**

This MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

Load Switch

SOT363



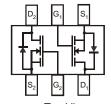
Top View

### **Features**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Mechanical Data**

- Case: SOT-363
- Case Material: Molded Plastic. "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe.
   Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



Top View Internal Schematic

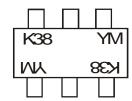
### Ordering Information (Note 5)

| Part Number  | Case   | Packaging          |
|--------------|--------|--------------------|
| BSS138DWQ-7  | SOT363 | 3,000/Tape & Reel  |
| BSS138DWQ-13 | SOT363 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



K38 = Product Type Marking Code YM = Date Code Marking Y or = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

| Year  | 2005 | 2006 |     | 2016 | 2017 | 7 20 | 18 2 | 019 | 2020 | 2021 | 2022 | 2023 |
|-------|------|------|-----|------|------|------|------|-----|------|------|------|------|
| Code  | S    | T    |     | D    | Е    | F    | :    | G   | Н    | 1    | J    | K    |
| Month | lan  | F-1  |     |      |      |      |      |     |      |      | T    |      |
| WOUTH | Jan  | Feb  | Mar | Apr  | May  | Jun  | Jul  | Aug | Sep  | Oct  | Nov  | Dec  |

April 2016

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## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic              | ;          | Symbol           | BSS138DW | Units |
|-----------------------------|------------|------------------|----------|-------|
| Drain-Source Voltage        |            | $V_{DSS}$        | 50       | V     |
| Drain-Gate Voltage (Note 8) |            | $V_{DGR}$        | 50       | V     |
| Gate-Source Voltage         | Continuous | V <sub>GSS</sub> | ±20      | V     |
| Drain Current (Note 6)      | Continuous | I <sub>D</sub>   | 200      | mA    |

# Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic                          | Symbol                            | BSS138DW    | Units |
|-----------------------------------------|-----------------------------------|-------------|-------|
| Total Power Dissipation (Note 6)        | $P_{D}$                           | 200         | mW    |
| Thermal Resistance, Junction to Ambient | $R_{	heta JA}$                    | 625         | °C/W  |
| Operating and Storage Temperature Range | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C    |

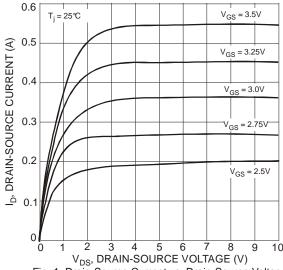
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

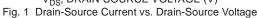
| Characteristic                    | Symbol              | Min | Тур | Max  | Unit | Test Condition                               |  |
|-----------------------------------|---------------------|-----|-----|------|------|----------------------------------------------|--|
| OFF CHARACTERISTICS (Note 7)      |                     |     |     |      |      |                                              |  |
| Drain-Source Breakdown Voltage    | BV <sub>DSS</sub>   | 50  | 75  | _    | V    | $V_{GS} = 0V, I_D = 250\mu A$                |  |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>    | _   | _   | 0.5  | μΑ   | $V_{DS} = 50V$ , $V_{GS} = 0V$               |  |
| Gate-Body Leakage                 | I <sub>GSS</sub>    | _   | _   | ±100 | nA   | $V_{GS} = \pm 20V, V_{DS} = 0V$              |  |
| ON CHARACTERISTICS (Note 7)       |                     |     |     |      |      |                                              |  |
| Gate Threshold Voltage            | V <sub>GS(TH)</sub> | 0.5 | 1.2 | 1.5  | >    | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$         |  |
| Static Drain-Source On-Resistance | R <sub>DS(ON)</sub> |     | 1.4 | 3.5  | Ω    | $V_{GS} = 10V, I_D = 0.22A$                  |  |
| Forward Transconductance          | <b>g</b> FS         | 100 | _   | _    | mS   | $V_{DS} = 25V$ , $I_D = 0.2A$ , $f = 1.0KHz$ |  |
| DYNAMIC CHARACTERISTICS           |                     |     |     |      |      |                                              |  |
| Input Capacitance                 | C <sub>ISS</sub>    |     |     | 50   | рF   |                                              |  |
| Output Capacitance                | Coss                |     | _   | 25   | рF   | $V_{DS} = 10V, V_{GS} = 0V, f = 1.0MHz$      |  |
| Reverse Transfer Capacitance      | C <sub>RSS</sub>    | _   | _   | 8.0  | pF   | 1                                            |  |
| SWITCHING CHARACTERISTICS         |                     |     |     |      |      |                                              |  |
| Turn-On Delay Time                | t <sub>D(ON)</sub>  |     |     | 20   | ns   | $V_{DD} = 30V, I_D = 0.2A,$                  |  |
| Turn-Off Delay Time               | t <sub>D(OFF)</sub> |     |     | 20   | ns   | $R_{GEN} = 50\Omega$                         |  |

Notes:

- 6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.
- $8. \quad R_{GS} \leq 20 K \Omega.$







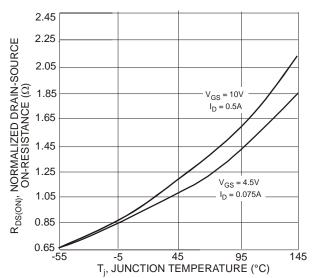


Fig. 3 Drain-Source On Resistance vs. Junction Temperature

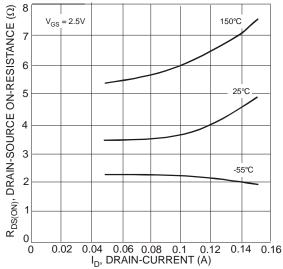
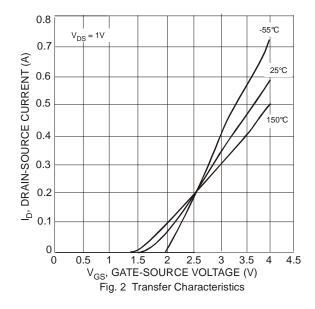


Fig. 5 Drain-Source On-Resistance vs. Drain-Current



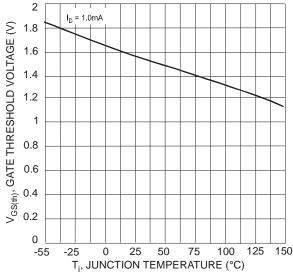


Fig. 4 Gate Threshold Voltage vs. Junction Temperature

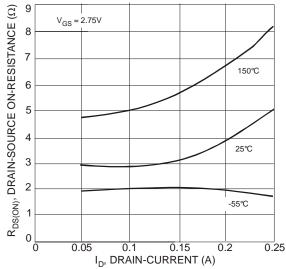
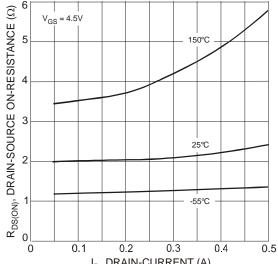
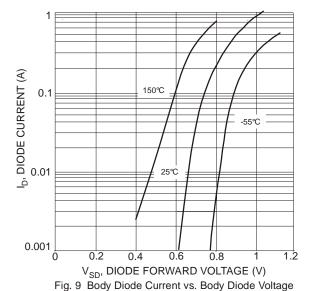


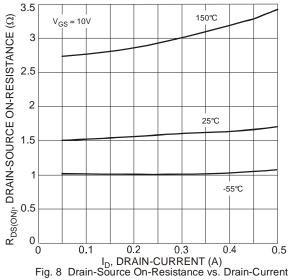
Fig. 6 Drain-Source On-Resistance vs. Drain-Current





I<sub>D</sub>, DRAIN-CURRENT (A)
Fig. 7 Drain-Source On-Resistance vs. Drain-Current





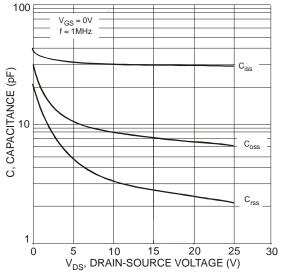


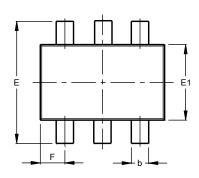
Fig. 10 Capacitance vs. Drain-Source Voltage

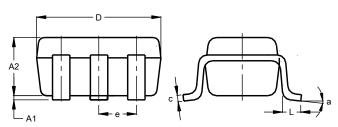


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



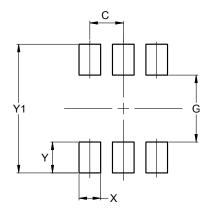


| SOT363               |           |      |       |  |  |  |
|----------------------|-----------|------|-------|--|--|--|
| Dim                  | Min       | Max  | Тур   |  |  |  |
| A1                   | 0.00      | 0.10 | 0.05  |  |  |  |
| A2                   | 0.90      | 1.00 | 1.00  |  |  |  |
| b                    | 0.10      | 0.30 | 0.25  |  |  |  |
| С                    | 0.10      | 0.22 | 0.11  |  |  |  |
| D                    | 1.80      | 2.20 | 2.15  |  |  |  |
| Е                    | 2.00      | 2.20 | 2.10  |  |  |  |
| E1                   | 1.15      | 1.35 | 1.30  |  |  |  |
| е                    | 0.650 BSC |      |       |  |  |  |
| F                    | 0.40      | 0.45 | 0.425 |  |  |  |
| L                    | 0.25      | 0.40 | 0.30  |  |  |  |
| а                    | 0°        | 8°   | _     |  |  |  |
| All Dimensions in mm |           |      |       |  |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| С          | 0.650            |
| G          | 1.300            |
| Х          | 0.420            |
| Y          | 0.600            |
| Y1         | 2.500            |



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